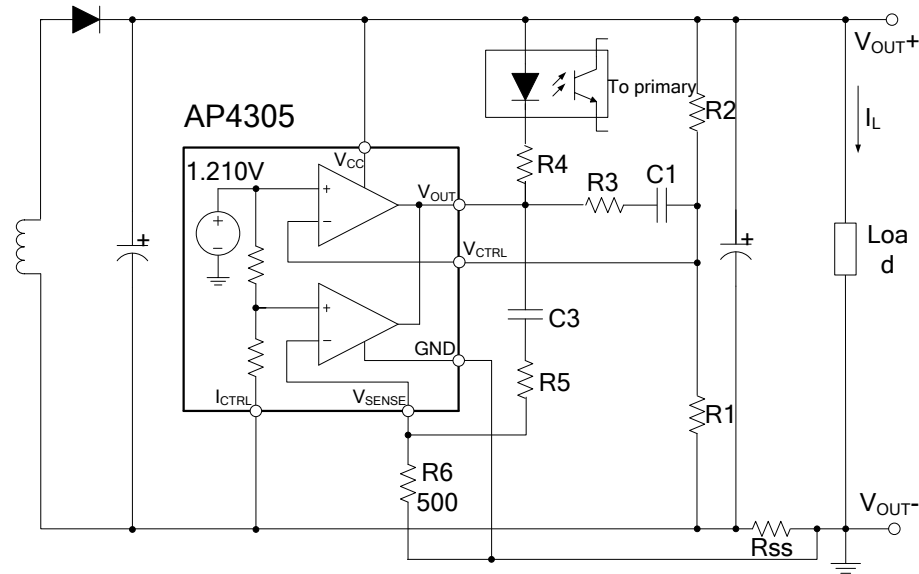


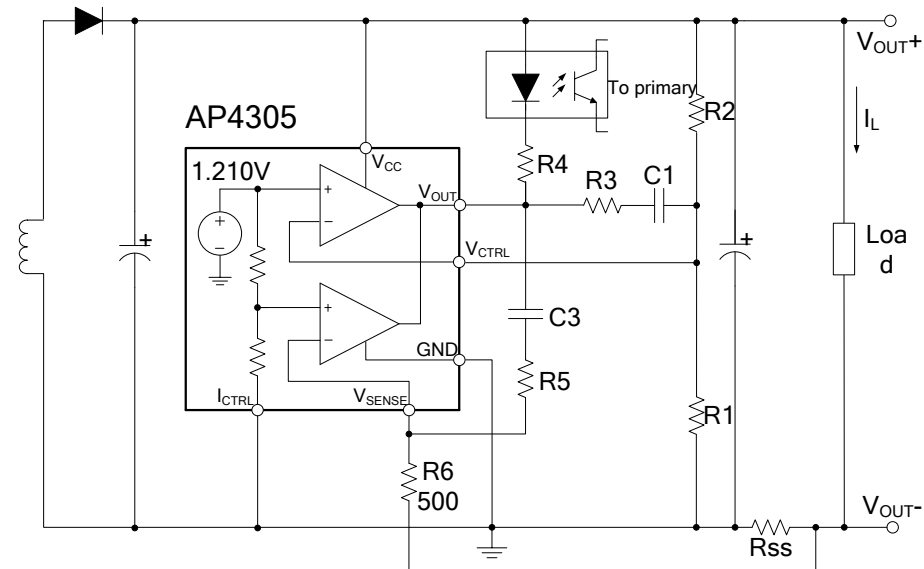
Typical Applications Circuit (Cont.)



$$V_{OUT} = [V_{REF} + (I_L \times R_{SS})] \times \frac{R1 + R2}{R1} - (I_L \times R_{SS}) \text{ (V)}$$

$$CurrentLimit = \frac{V_{SENSE}}{R_{SS}} \text{ (A)}$$

Typical Application 2



$$V_{OUT} = V_{REF} \times \frac{R1 + R2}{R1} - (I_L \times R_{SS}) \text{ (V)}$$

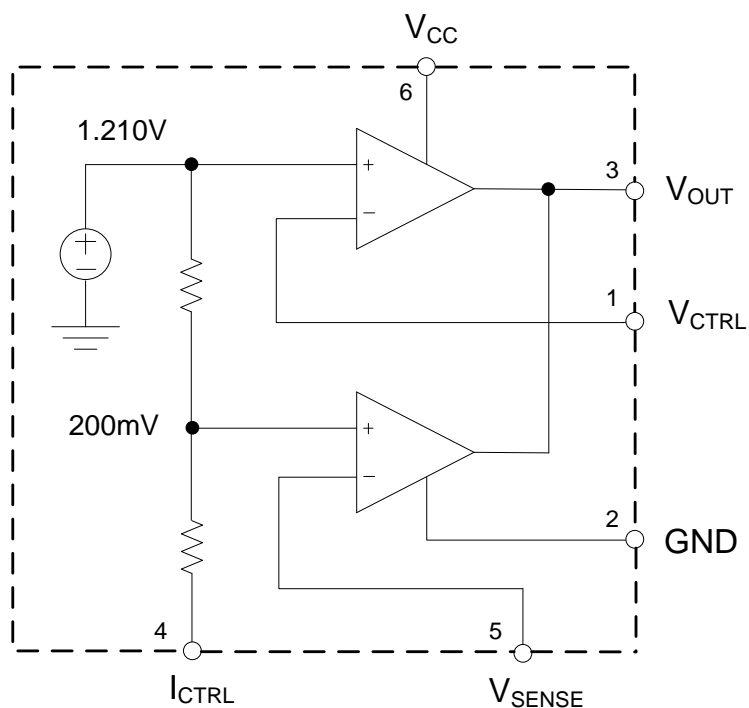
$$CurrentLimit = \frac{V_{SENSE} \times V_{REF}}{(V_{SENSE} + V_{REF}) \times R_{SS}} \text{ (A)}$$

Typical Application 3

Pin Descriptions

Pin Number	Pin Name	Function
1	V_{CTRL}	Input pin of the voltage control loop
2	GND	Ground
3	V_{OUT}	Output pin. Sinking current only
4	I_{CTRL}	Input pin of the current control loop
5	V_{SENSE}	Input pin of the current control loop
6	V_{CC}	Power supply

Functional Block Diagram



Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
V_{CC}	Power Supply Voltage	20	V
V_{IN}	Input Voltage	-0.3 to V_{CC}	V
T_J	Junction Temperature	+150	°C
T_{STG}	Storage Temperature	-65 to +150	°C
T_{LEAD}	Lead Temperature (Soldering, 5sec)	+260	°C
θ_{JC}	Package Thermal Resistance (Junction to Case)	92	°C/W

Note 4: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions

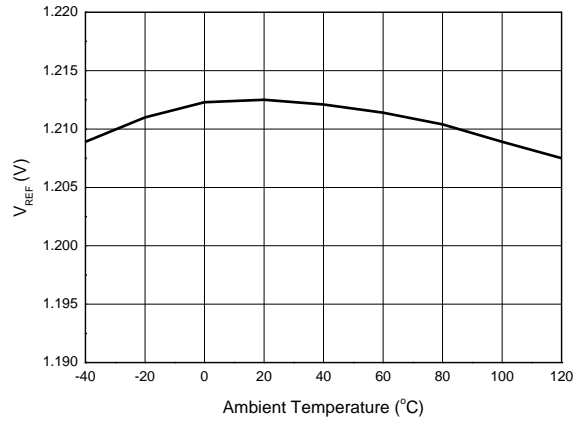
Symbol	Parameter	Min	Max	Unit
V_{CC}	Power Supply Voltage	2.5	18	V
T_A	Operating Temperature Range	-40	+105	°C

Electrical Characteristics ($V_{CC}=5V$, $T_A=+25^{\circ}C$, unless otherwise specified.)

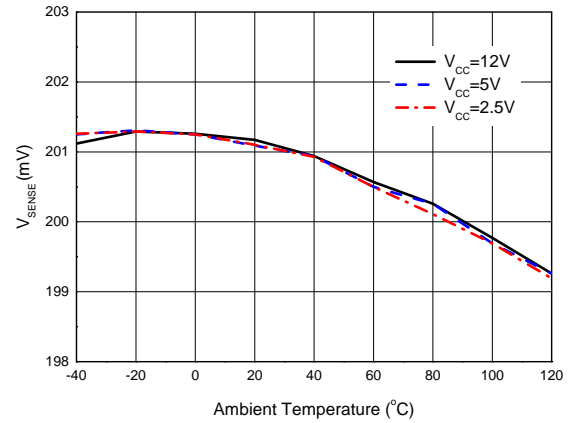
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
TOTAL CURRENT CONSUMPTION						
I _{CC}	Total Supply Current Not Including the Output Sinking Current	T _A =+25°C	–	0.5	1	mA
		-40°C<T _A < +105°C	–	0.6	–	
VOLTAGE CONTROL LOOP						
G _{mv}	Transconduction Gain (V _{CTRL}). Sink Current Only	T _A =+25°C	1	3.5	–	mA/mV
		-40°C<T _A < +105°C	–	2.5	–	
V _{REF}	Voltage Control Loop Reference	T _A =+25°C	1.204	1.21	1.216	V
		-40°C<T _A < +105°C	1.186	–	1.234	
I _{IBV}	Input Bias Current (V _{CTRL})	T _A =+25°C	–	50	–	nA
		-40°C<T _A < +105°C	–	100	–	
CURRENT CONTROL LOOP						
G _{mi}	Transconduction Gain (I _{CTRL}). Sink Current Only	T _A =+25°C	1.5	7	–	mA/mV
V _{SENSE}	Current Control Loop Reference	I _{OUT} =2.5mA, T _A =+25°C	198	200	202	mV
		I _{OUT} =2.5mA, -40°C<T _A < +105°C	192	–	208	
I _{IBI}	Current Out of Pin I _{CTRL} at 200mV	T _A =+25°C	–	25	–	μA
		-40°C<T _A < +105°C	–	50	–	
OUTPUT STAGE						
V _{OL}	Low Output Voltage at 10mA Sinking Current	T _A =+25°C	–	200	–	mV
I _{OS}	Output Short Circuit Current. Output to V _{CC} , Sink Current Only	T _A =+25°C	–	27	50	mA
		-40°C<T _A < +105°C	–	35	–	

Performance Characteristics

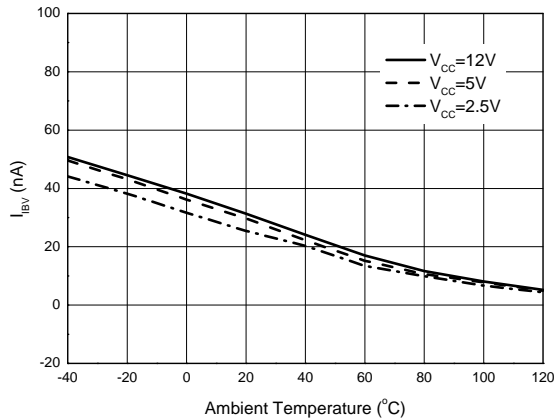
V_{REF} vs. Ambient Temperature



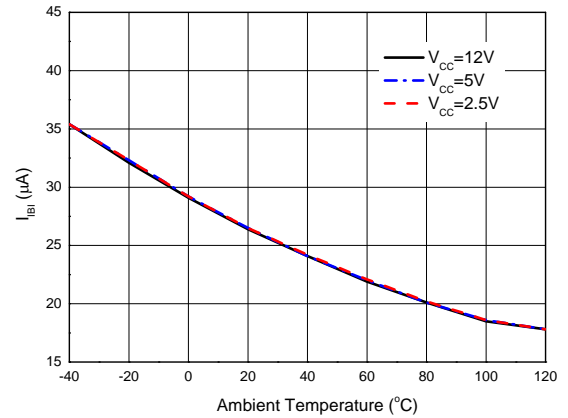
V_{SENSE} vs. Ambient Temperature



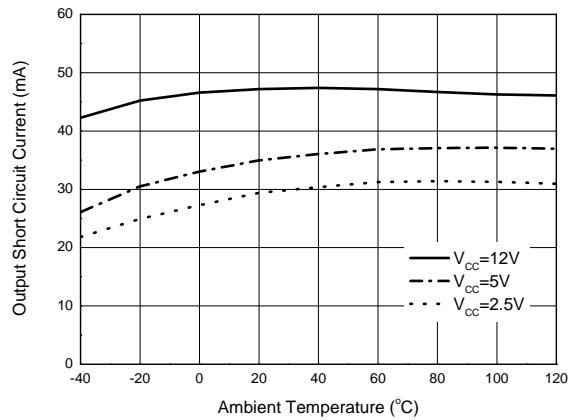
I_{IBV} vs. Ambient Temperature



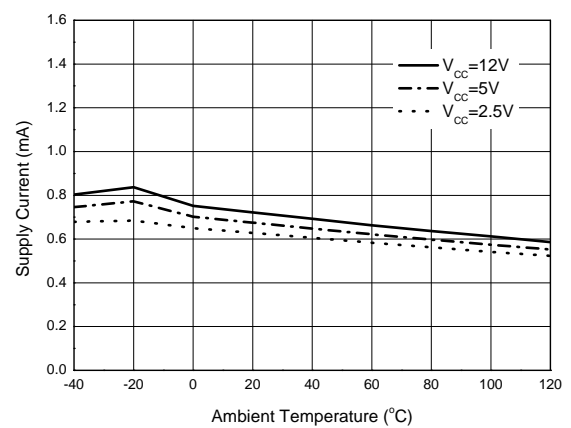
I_{BI} vs. Ambient Temperature



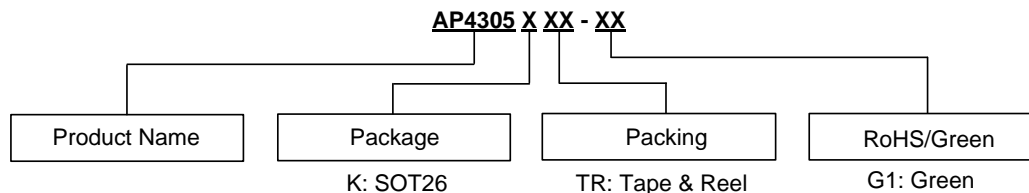
Output Short Circuit Current vs. Ambient Temperature



Supply Current vs. Ambient Temperature



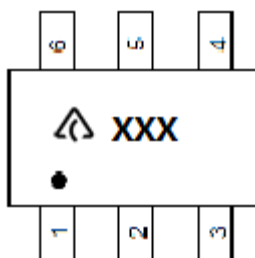
Ordering Information



Package	Temperature Range	Part Number	Marking ID	Packing
SOT26	-40 to +105°C	AP4305KTR-G1	G2B	3000/Tape & Reel

Marking Information

(Top View)

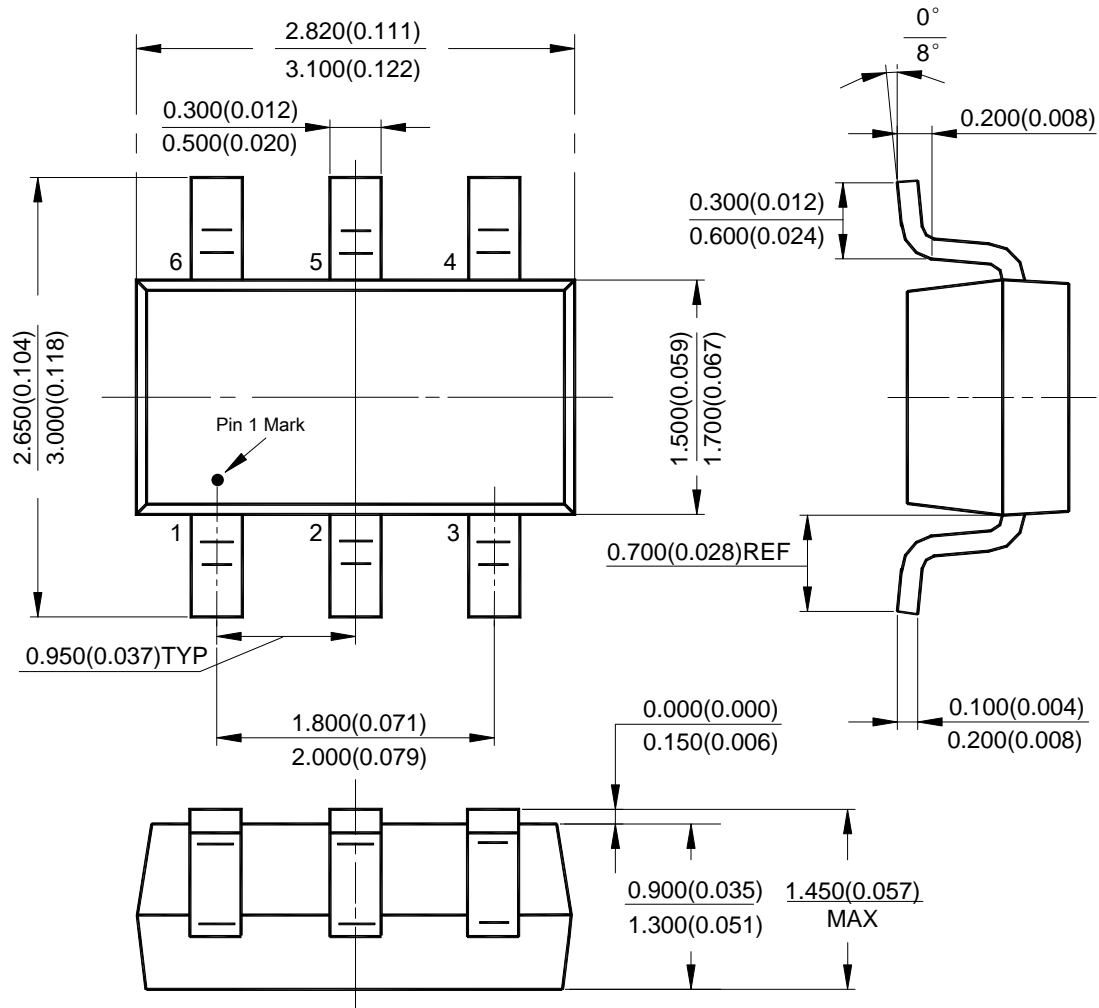


: Logo

XXX: Marking ID (See Ordering Information)

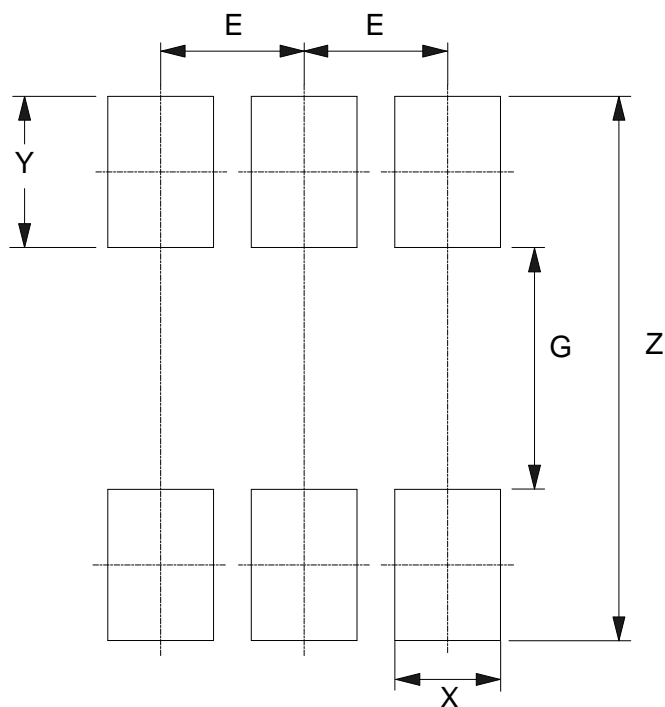
Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: SOT26



Suggested Pad Layout

(1) Package Type: SOT26



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037

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